Preferred Device

# SWITCHMODE™ Power Rectifier

These state–of–the–art devices use the Schottky Barrier principle with a proprietary barrier metal.

#### Features

- Guardring for Stress Protection
- Maximum Die Size
- 175°C Operating Junction Temperature
- Short Heat Sink Tab Manufactured Not Sheared
- Pb–Free Packages are Available

#### Mechanical Characteristics:

- Case: Epoxy, Molded, Epoxy Meets UL 94 V-0
- Weight: 1.7 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL1 Requirements
- ESD Ratings: Machine Model, C (>400 V) Human Body Model, 3B (>8000 V)

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
Average Rectified Forward Current(At Rated $V_R$ , $T_C = 134$ °C)Per Device Per Leg	I <sub>F(AV)</sub>	30 15	A
Peak Repetitive Forward Current (At Rated $V_R$ , Square Wave, 20 kHz, T <sub>C</sub> = +137°C) Per Leg	I <sub>FRM</sub>	30	A
Non–Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions, Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	200	A
Peak Repetitive Reverse Surge Current (2.0 $\mu$ s, 1.0 kHz)	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-55 to +175	°C
Operating Junction Temperature (Note 1)	TJ	-55 to +175	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/µs
Reverse Energy (Unclamped Inductive Surge) (Inductance = 3 mH, T <sub>C</sub> = 25°C)	W	100	mJ

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

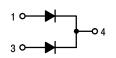
1. The heat generated must be less than the thermal conductivity from Junction-to-Ambient: dP\_D/dT\_J <  $1/R_{\theta JA}$ .



## **ON Semiconductor®**

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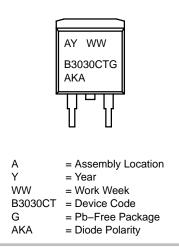
# SCHOTTKY BARRIER RECTIFIER 30 AMPERES, 30 VOLTS





D<sup>2</sup>PAK CASE 418B STYLE 3

#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

**Preferred** devices are recommended choices for future use and best overall value.

#### THERMAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Value	Unit
Thermal Resistance, – Junction-to-Case – Junction-to-Ambient (Note 2)	$R_{ heta JC}$ $R_{ heta JA}$	1.0 50	°C/W

2. When mounted using minimum recommended pad size on FR-4 board.

#### ELECTRICAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 3), Per Leg ( $I_F = 15 \text{ Amps}, T_C = +25^{\circ}\text{C}$ ) ( $I_F = 15 \text{ Amps}, T_C = +150^{\circ}\text{C}$ ) ( $I_F = 30 \text{ Amps}, T_C = +25^{\circ}\text{C}$ ) ( $I_F = 30 \text{ Amps}, T_C = +150^{\circ}\text{C}$ )	V <sub>F</sub>	0.54 0.47 0.67 0.66	V
Maximum Instantaneous Reverse Current (Note 3), Per Leg (Rated dc Voltage, $T_C = +25^{\circ}C$ ) (Reverse Voltage = 10 V, $T_C = +150^{\circ}C$ ) (Rated dc Voltage, $T_C = +150^{\circ}C$ )	I <sub>R</sub>	0.6 46 145	mA

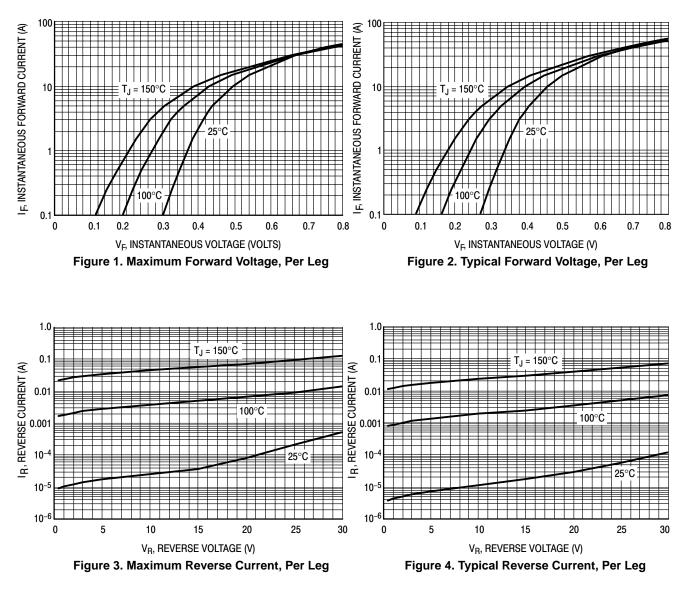
3. Pulse Test: Pulse Width =  $300 \ \mu$ s, Duty Cycle  $\leq 2.0\%$ .

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MBRB3030CT	D <sup>2</sup> PAK	50 Units / Rail
MBRB3030CTG	D <sup>2</sup> PAK (Pb–Free)	50 Units / Rail
MBRB3030CTT4	D <sup>2</sup> PAK	800 Units / Tape & Reel
MBRB3030CTT4G	D <sup>2</sup> PAK (Pb–Free)	800 Units / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **ELECTRICAL CHARACTERISTICS**



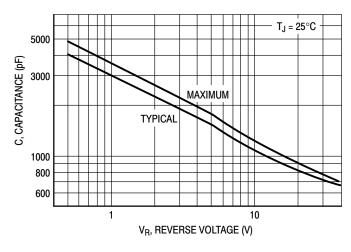
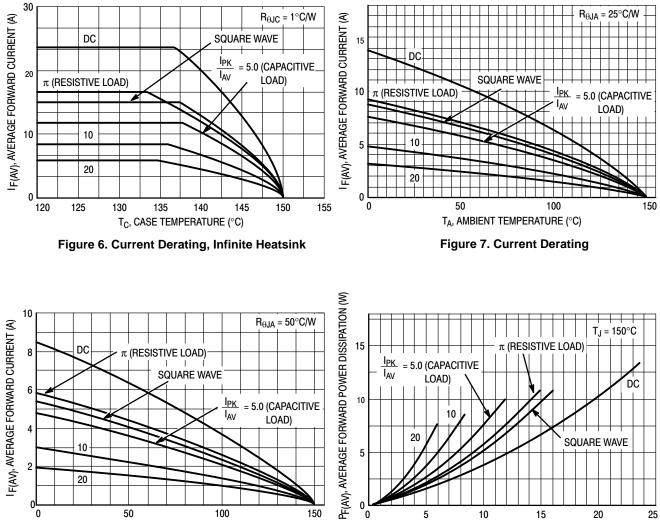


Figure 5. Capacitance

#### **TYPICAL CHARACTERISTICS**



0 100 150 5 15 20 25 0 10 T<sub>A</sub>, AMBIENT TEMPERATURE (°C) IF(AV), AVERAGE FORWARD CURRENT (A) Figure 8. Current Derating, Free Air **Figure 9. Forward Power Dissipation** 

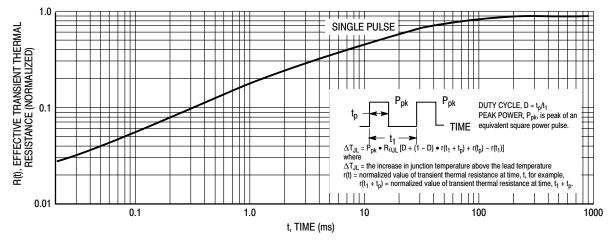


Figure 10. Thermal Response

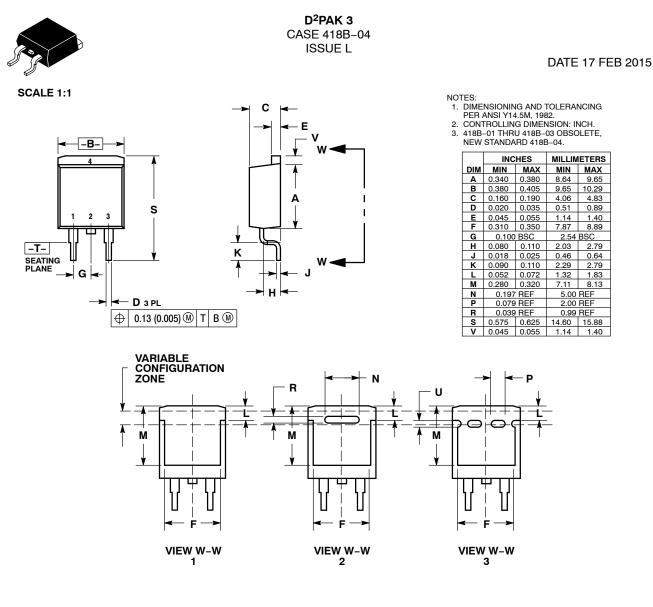
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# **ONSEMI**



STYLE 1:	STYLE 2:	STYLE 3:	STYLE 4:	STYLE 5:	STYLE 6:
PIN 1. BASE	PIN 1. GATE	PIN 1. ANODE	PIN 1. GATE	PIN 1. CATHODE	PIN 1. NO CONNECT
2. COLLECTOR	2. DRAIN	2. CATHODE	2. COLLECTOR	2. ANODE	2. CATHODE
3. EMITTER	<ol><li>SOURCE</li></ol>	<ol><li>ANODE</li></ol>	3. EMITTER	<ol><li>CATHODE</li></ol>	3. ANODE
4. COLLECTOR	4. DRAIN	<ol><li>CATHODE</li></ol>	4. COLLECTOR	4. ANODE	4. CATHODE

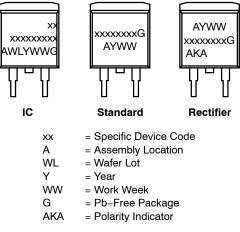
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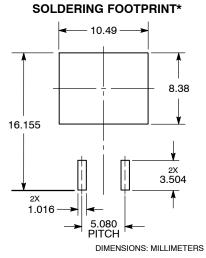
#### D<sup>2</sup>PAK 3 CASE 418B-04 ISSUE L

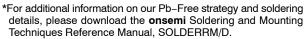
#### DATE 17 FEB 2015

#### GENERIC MARKING DIAGRAM\*



\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.





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